# Amphenol



# CAMM2 Connector (Compression Attached Memory Module)

## CAMM2 IS THE NEXT-GENERATION MEMORY INTERCONNECT

Amphenol is introducing the CAMM2 connector which is a JEDEC standard and comes in several stack heights and pin sizes. CAMM2 uses Amphenol cLGA® direct-attach compression technology for high-performance and low stack height for today's thin laptops.

- Amphenol cLGA<sup>®</sup> contact technology is field-proven for over 20 years
- Shunted contact and/or ground shielding in selective configuration technology provides superior SI performance
- Direct attach compression allows field replacement without soldering
- Contacts are self-centering for reliability
- Contact tips are contained in the housing to avoid damage



### **FEATURES**

- JEDEC standard design
- Contact shunting and/or shielding feature
- Floating contacts design
- Contact tip contained in the housing cavity

### **BENEFITS**

- Wide Industry acceptance
- Superior SI performance
- Self-center to compensate for chip or PCB warpage
- Prevent bent pin or handling damage

## **TECHNICAL INFORMATION**

#### MATERIAL

- Housing: High-temperature thermoplastic UL94-V0
- Contact: Copper Alloy, 10µ Gold plating
- CAP: Thermoplastic

#### **ELECTRICAL PERFORMANCE**

• Current Rating: 1.0A

### **MECHANICAL PERFORMANCE**

- Durability: 60 cycles
- SPECIFICATIONS
- JEDEC CAMM2

## **PART NUMBERS**

| Description                 | Part Numbers |
|-----------------------------|--------------|
| CAMM2 1.0MM LPDDR           | IC14791001   |
| CAMM2 2.85MM Dual Channel   | IC14878001   |
| CAMM2 2.85MM Single Channel | IC14940001   |

Find part number details using the search box on www.amphenol-cs.com

#### PACKAGING

Tray

#### **TARGET MARKETS/APPLICATIONS**



Notebook Desktop



Server

## www.amphenol-cs.com

#### Disclaimer

Please note that the above information is subject to change without notice.